

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







Constant Voltage / Constant Current Secondary-Side Controller

Description

The NCS1002A is a performance upgrade from the NCS1002 focused on reducing power consumption in applications that require more efficient operation. It is a highly integrated solution for Switching Mode Power Supply (SMPS) applications requiring a dual control loop to perform Constant Voltage (CV) and Constant Current (CC) regulation. The NCS1002A integrates a 2.5 V voltage reference and two precision op amps. The voltage reference, along with Op Amp 1, is the core of the voltage control-loop. Op Amp 2 is an independent, uncommitted amplifier specifically designed for the current control. Key external components needed to complete the two control loops are: (a) A resistor divider that senses the output of the power supply (battery charger) and fixes the voltage regulation set point at the specified value. (b) A sense resistor that feeds the current sensing circuit with a voltage proportional to the DC output current. This resistor determines the current regulation set point and must be adequately rated in terms of power dissipation. The NCS1002A comes in a small 8-pin SOIC package and is ideal for space-shrunk applications such as battery chargers.

Features

- Low Input Offset Voltage: 0.5 mV, Typ
- Input Common-Mode Range includes Ground
- Low Quiescent Current: 75 μ A per Op Amp at $V_{CC} = 5 \text{ V}$
- Large Output Voltage Swing
- Wide Power Supply Range: 3 V to 36 V
- High ESD Protection: 2 kV
- This is a Pb-Free Device

Typical Applications

- Battery Chargers
- Switch Mode Power Supplies



ON Semiconductor®

http://onsemi.com

MARKING DIAGRAMS



SOIC-8 D SUFFIX CASE 751



= Assembly Location

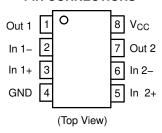
L = Wafer Lot Y = Year

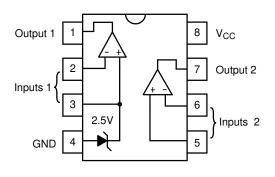
W = Work Week

= Pb-Free Package

(Note: Microdot may be in either location)

PIN CONNECTIONS





ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 8 of this data sheet.

MAXIMUM RATINGS

Parameter	Symbol	Rating	Unit
Supply Voltage (V _{CC} to GND) (Operating Range V _{CC} = 3 V to 36 V)	V _{CC}	36	V
Differential Input Voltage	V _{id}	36	V
Input Voltage	Vi	-0.3 to +36	V
ESD Protection Voltage at Pin Human Body Model	V _{ESD}	2000	V
Maximum Junction Temperature	T _J	150	°C
Specification Temperature Range (T _{min} to T _{max})	T _A	-40 to +105	°C
Operating Free-Air Temperature Range	T _{oper}	-55 to +125	°C
Storage Temperature Range	T _{stg}	−55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Parameter		Symbol	Rating	Unit
Thermal Resistance	Junction-to-Ambient	R_{\thetaJA}	175	°C/W

ELECTRICAL CHARACTERISTICS

Symbol	Characteristics	Conditions	Min	Тур	Max	Unit
I _{CC}	Total Supply Current, excluding current in the Voltage Reference V_{CC} = 5 V, no load; $-40 \le T_A \le +105^{\circ}C$			0.15	0.25	mA
Icc	Total Supply Current, excluding Current in the Voltagload; $-40 \le T_A \le +105$ °C	ge Reference V _{CC} = 30 V, no		0.2	0.3	mA

OP AMP 1 (OP AMP WITH NONINVERTING INPUT CONNECTED TO THE INTERNAL V_{ref}) (V $_{CC}$ = 5 V, T $_{A}$ = 25°C unless otherwise noted)

V_{IO}	Input Offset Voltage	T _A = 25°C			2.0	mV
		$-40 \le T_A \le +105^{\circ}C$			3.0	mV
DV _{IO}	Input Offset Voltage Drift (-40 ≤ T _A ≤ +105°C)			7.0		μV/°C
I _{IB}	Input Bias Current (Inverting Input Only)			20	150	nA
AVD	Large Signal Voltage Gain (V_{CC} = 15 V, R_L = 2 k Ω , V_{ICM} = 0 V)			100		V/mV
PSRR	Power Supply Rejection (V _{CC} = 5.0 V to 30 V, V _{OUT}	= 2 V)	80	100		dB
I _{SOURCE}	Output Source Current (V _{CC} = 15 V, V _{OUT} = 2.0 V, V _{id} = 1 V)		20	40		mA
I _O	Short Circuit to GND (V _{CC} = 15 V)	nort Circuit to GND (V _{CC} = 15 V)		40	60	mA
I _{SINK}	Output Current Sink (V _{id} = -1 V)	V _{CC} = +15 V, V _{OUT} = 0.2 V (Note 1)	1	10		mA
		V _{CC} = +15 V, V _{OUT} = 2 V	10	20		mA
V _{OH}	Output Voltage Swing, High (V _{CC} = 30 V)	$R_L = 2 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$	26	27		V
		$-40 \le T_A \le +105^{\circ}C$	26			
		$R_L = 10 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$	27	28		
		$-40 \le T_A \le +105^{\circ}C$	27			
V _{OL}	Output Voltage Swing, Low	$R_L = 10 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$		5.0	50	mV
SR	Slew Rate (AV = +1, V_i = 0.5 V to 2 V, V_{CC} = 15 V, R_L = 2 k Ω , C_L = 100 pF)		0.2	0.4		V/μs
GBP	Gain Bandwidth Product (V_{CC} = 30 V, AV = +1, (Note 1) R _L = 2 k Ω , C _L = 100 pF, f = 100 kHz, V _{IN} = 10 mV _{PP})		0.5	0.9		MHz
THD	Total Harmonic Distortion (f = 1 kHz, AV = 10, $R_L = 2 k\Omega$, $V_{CC} = 30 V$, $V_{OUT} = 2 V_{PP}$)			0.08		%

OP AMP 2 (INDEPENDENT OP AMP) $(V_{CC} = 5.0 \text{ V}, T_A = 25^{\circ}\text{C} \text{ unless otherwise noted})$

V _{IO}	Input Offset Voltage	T _A = 25°C		0.5	2.0	mV
		$-40 \le T_A \le +105^{\circ}C$			3.0	
DV _{IO}	Input Offset Voltage Drift ($-40 \le T_A \le +105^{\circ}C$)			7.0		μV/°C
I _{IO}	Input Offset Current	T _A = 25°C		2.0	75	nA
		$-40 \le T_A \le +105^{\circ}C$			150	
Ι _Β	Input Bias Current	T _A = 25°C		20	150	nA
		$-40 \le T_A \le +105^{\circ}C$			200	
AVD	Large Signal Voltage Gain (V_{CC} = 15 V, R _L = 2 kΩ, V _{OUT} = 1.4 V to 11.4 V)	T _A = 25°C	50	100		V/mV
	$R_L = 2 \text{ Ks2}, V_{OUT} = 1.4 \text{ V to } 11.4 \text{ V}$	$-40 \le T_A \le +105^{\circ}C$	25			
PSRR	Power Supply Rejection (V _{CC} = 5 V to 30 V)		80	100		dB

^{1.} Guaranteed by design and/or characterization.

ELECTRICAL CHARACTERISTICS (continued)

Symbol	Characteristics	Conditions	Min	Тур	Max	Unit
OP AMP 2	(INDEPENDENT OP AMP) (continued) ($V_{CC} = 5.0$	V, T _A = 25°C unless otherwise	noted)	•		
V _{ICM}	Input Common Mode Voltage Range (Note 2) (V _{CC} = +30 V)	T _A = 25°C	0		V _{CC} – 1.5	V
		$-40 \le T_A \le +105^{\circ}C$	0		V _{CC} – 2.0	
CMRR	Common Mode Rejection Ratio (Note 4)	0 to V _{CC} – 1.7 V, T _A = 25°C	70	85		dB
		$0 \text{ to V}_{CC} - 2.2 \text{ V} \\ -40 \le T_A \le +105^{\circ}\text{C}$	60			
I _{SOURCE}	Output Current Source (V _{CC} = 15 V, V _{OUT} = 2 V, V _{II}	_O = +1 V)	20	40		mA
I _O	Short–Circuit to GND (V _{CC} = 15 V)			40	60	mA
I _{SINK}	Output Current Sink (V _{ID} = -1 V)	$V_{CC} = +15 \text{ V}, V_{OUT} = 0.2 \text{ V}$	1	10		mA
		V _{CC} = +15 V, V _{OUT} = 2 V	10	20		mA
V _{OH}	Output Voltage Swing, High (V _{CC} = 30 V)	$R_L = 2 \text{ k}\Omega$, $T_A = 25^{\circ}\text{C}$	26	27		V
		$-40 \le T_A \le +105^{\circ}C$	26			
		$R_L = 10 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$	27	28		
		$-40 \le T_A \le +105^{\circ}C$	27			
V _{OL}	Output Voltage Swing, Low	$R_L = 10 \text{ k}\Omega, T_A = 25^{\circ}\text{C}$		5.0	50	mV
SR	Slew Rate (AV = +1, V_i = 0.5 V to 3 V, V_{CC} = 15 V, F	$R_L = 2 \text{ k}\Omega, C_L = 100 \text{ pF}$	0.2	0.4		V/μs
GBP	Gain Bandwidth Product (V_{CC} = 30 V, AV = +1, R _L = 2 k Ω , C _L = 100 pF, f = 100 kHz, V _{IN} = 10 mV _{PF}	b) (Note 4)	0.5	0.9		MHz
THD	Total Harmonic Distortion (f = 1 kHz, AV = 10, $R_L = 2 k\Omega$, $V_{CC} = 30 V$, $V_{OUT} = 2 V_{PP}$)			0.08		%
e _{noise}	Equivalent Input Noise Voltage (f = 1 kHz, R _S = 100	Ω, V _{CC} = 30 V)		50		nV/√ Hz
VOLTAGE	REFERENCE (V _{CC} = 5.0 V, T _A = 25°C unless otherw	rise noted)				
I _K	Cathode Current		0.05		100	mA
V _{ref}	Reference Voltage (I _K = 1 mA)	T _A = 25°C	2.49	2.5	2.51	V
		$-40 \le T_A \le +105^{\circ}C$	2.48	2.5	2.52	
ΔV_{ref}	Reference Deviation over Temperature (V _{KA} = V _{ref} , I _K = 10 mA, $-40 \le T_A \le +105^{\circ}C$) (Note 4)			7.0	30	mV
I _{min}	Minimum Cathode Current for Regulation (2.4875 $V_f \le V_{KA} \le 2.5125 V_f$)			10	50	μΑ
I ZKA I	Dynamic Impedance (Note 3) $(V_{KA} = V_{ref}, I_K = 1 \text{ mA to } 100 \text{ mA}, f < 1 \text{ kHz})$			0.2	0.5	Ω

The input common–mode voltage of either input signal should not be allowed to go negative by more than 0.3 V. The upper end of the common–mode range is V_{CC} – 1.5 V. Both inputs can go to V_{CC} + 0.3 V without damage.
 The Dynamic Impedance is defined as I ZKA I = ΔV_{KA} / ΔI_K.
 Guaranteed by design and/or characterization.

BIAS CURRENT (nA)

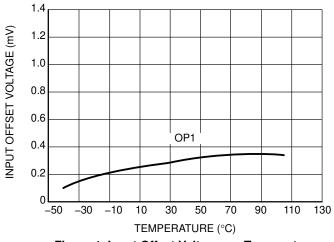


Figure 1. Input Offset Voltage vs. Temperature

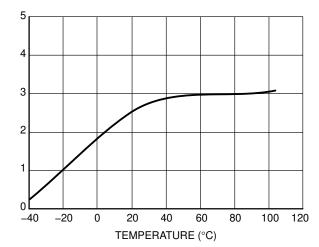


Figure 2. IB vs. Temperature

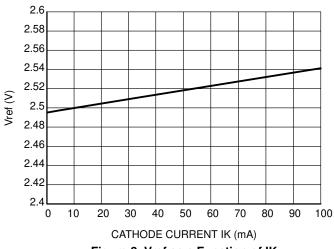


Figure 3. Vref as a Function of IK

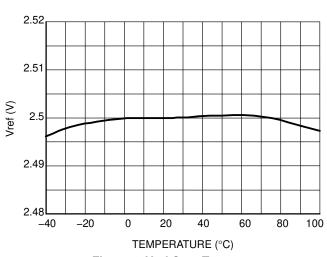


Figure 4. Vref Over Temperature

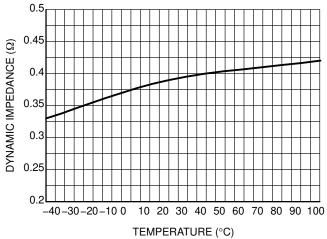
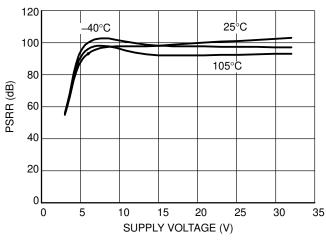


Figure 5. Ref Dynamic Impedance vs. Temperature



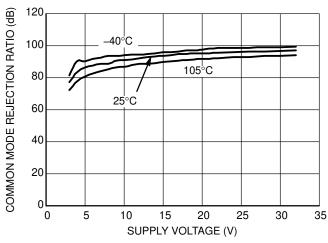


Figure 6. NCS1002A PSRR vs. Supply Voltage

Figure 7. NCS1002A CMRR vs. Supply Voltage

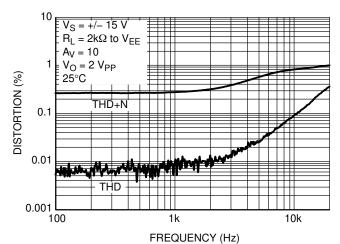


Figure 8. Distortion vs. Frequency

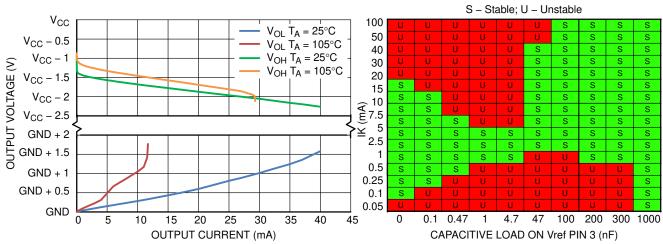


Figure 9. Output Voltage Swing vs. Output Current V_{id} = 1 V, V_{CM} = 0 V, V_{CC} = 3 V to 36 V

Figure 10. Region of Reference Stability vs. Capacitive Load (Pin 3)

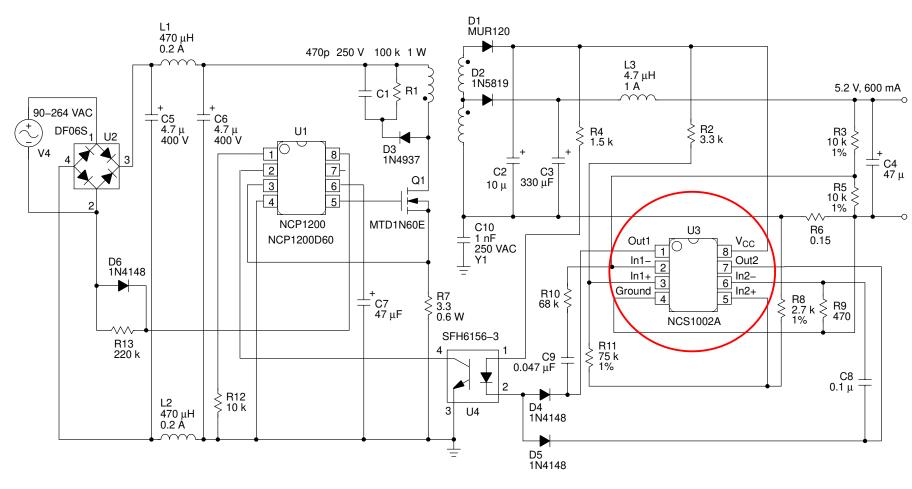


Figure 1. AC Adapter Application

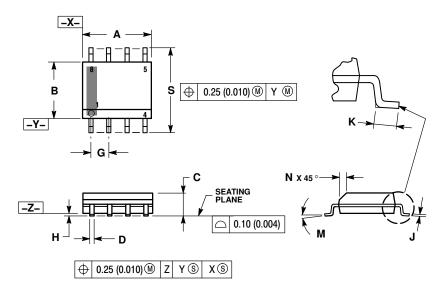
ORDERING INFORMATION

Device	Package	Shipping [†]
NCS1002ADR2G	SOIC-8 (Pb-Free)	2500 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

PACKAGE DIMENSIONS

SOIC-8 NB CASE 751-07 ISSUE AK

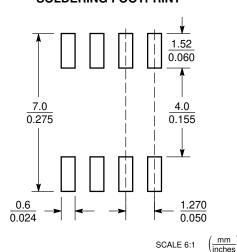


NOTES

- DIMENSIONING AND TOLERANCING PER
 ANSI V14 5M 1982
- ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: MILLIMETER.
- 3. DIMENSION A AND B DO NOT INCLUDE MOLD PROTRUSION.
- 4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
- 5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.
- 751–01 THRU 751–06 ARE OBSOLETE. NEW STANDARD IS 751–07.

	8411 1 184	IETEDO.	1110		
	MILLIMETERS			HES	
DIM	MIN	MAX	MIN	MAX	
Α	4.80	5.00	0.189	0.197	
В	3.80	4.00	0.150	0.157	
С	1.35	1.75	0.053	0.069	
D	0.33	0.51	0.013	0.020	
G	1.27	7 BSC	0.050 BSC		
Н	0.10	0.25	0.004	0.010	
7	0.19	0.25	0.007	0.010	
K	0.40	1.27	0.016	0.050	
М	0 ° 8 °		0 °	8 °	
N	0.25	0.50	0.010	0.020	
S	5.80	6.20	0.228	0.244	

SOLDERING FOOTPRINT



*For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

ON Semiconductor and war registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products or any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC osen to convey any license under its patent rights or the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/A

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA **Phone**: 303–675–2175 or 800–344–3860 Toll Free USA/Canada

Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910 Japan Customer Focus Center

Japan Customer Focus Center Phone: 81–3–5817–1050 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative